

Innovative test solutions



History and milestones



2003: Active Technologies is founded as University of Ferrara startup. Mission: develop custom oriented innovative test equipment

2007: Active Technologies is a 100% private company

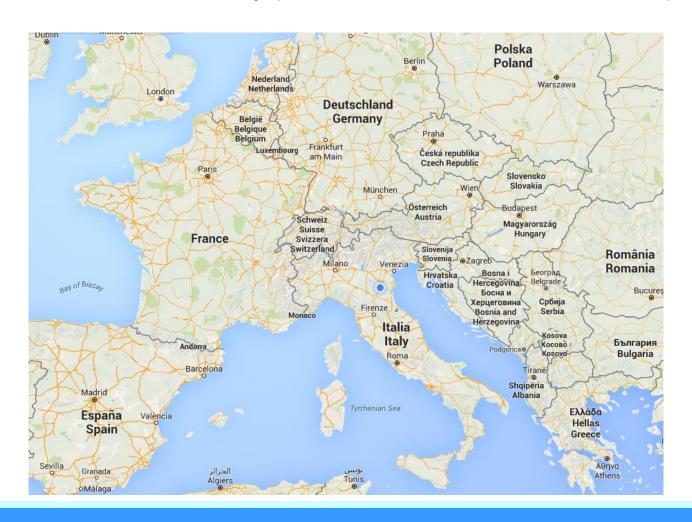
Achievements in 13 years of activity:

- OEM agreements with T&M leaders: Tektronix, LeCroy, NI
- Qualified supplier of custom test bench for semiconductor and Aerospace & Defence customers
- 5 partnerships in European Projects (ACT-ITALY PIC: 999735060)



Location

Ferrara: north-east of Italy (Between Florence and Venice)



Main Customers



















Eurpean projects



- GOSSAMER: http://www.fp7-gossamer.eu/
- ESTRELIA: http://www.estrelia.eu/
- ATHENIS 3D: http://www.athenis3d.eu/
- P-SOCRATES: http://www.p-socrates.eu/
- E!-VAMPA: http://vampa.epfl.ch/

AT Target market



- NVM semiconductor engineering tester
 - RIFLE and customized testing tools
- AT branded modular instruments
 - Arbitrary waveform generators
- OEM / Custom projects
 - OEM AWGs
 - High speed digitizer
 - Terabyte Record and Playback system



Cooperation with T&M leaders











AWG110x

AWG1102 / 1104 (Arbstudio)

- 2 4 channel models
- Up to 8 stackable units (32 channels)
- 16 bit vertical resolution
- 2Mpts per channel
- 250 Ms/s update rate (1G interleaved)
- 125MHz analogue bandwidth (3ns rise time)
- 12Vpp 50ohm (24Vpp open) output swing
- Up to 36 digital outputs







AWG GS2500

AWG-GS-2500

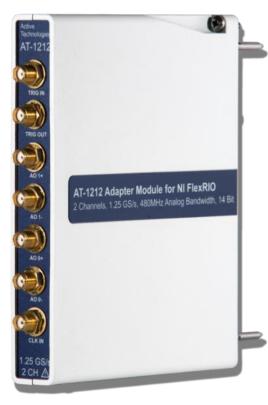
- 2 channel model
- Up to 2 stackable units (4 ch)
- 14 bit vertical resolution
- 64Mpts per channel
- 2.5 Gs/s update rate
- > 1GHz analogue bandwidth (280ps rise time)
- 2Vpp 50ohm (4Vpp open) output swing
- Up to 32 digital outputs





Flex-RIO Adapter Module

- Adapter module for Flex-RIO platform
- 1 Channel model (AT-1120):
 - 2 Gsps update rate 14 bit vertical resolution
 - 800 MHz Bandwidth
- 2 Channel model (AT-1212):
 - 1.2 Gsps update rate 14 bit vertical resolution
 - 480 MHz Bandwidth



Now distributed by NI's WW sales channel:

http://sine.ni.com/nips/cds/view/p/lang/it/nid/211055



AWG Patent

Active Technologies patented a specific core for signal generation called ATDS

- Italian Patent already approved
- US extension on going
- European extension on going



ATTESTATO DI BREVETTO PER INVENZIONE INDUSTRIALE

N. 0001415960

Il presente brevetto viene concesso per l'invenzione della domanda sotto specificata:

| num. domanda | anno | C.C.I.A.A. | data pres. domanda | classifica |
|--------------|------|------------|--------------------|------------|
| 000068 | 2013 | BOLOGNA | 18/02/2013 | G06F1 03 |

TITOLARE/I ACTIVE TECHNOLOGIES S.R.L. FERRARA

MANDATARIO FIORINI ANDREA

INDIRIZZO STUDIO TORTA S.P.A.

0121 TORING

TITOLO METODO E SISTEMA PER LA SINTESI DIGITALE DI UNA FORMA

D'ONDA

INVENTORE/I PELLATI PAOLO



Roma, 18/05/2015

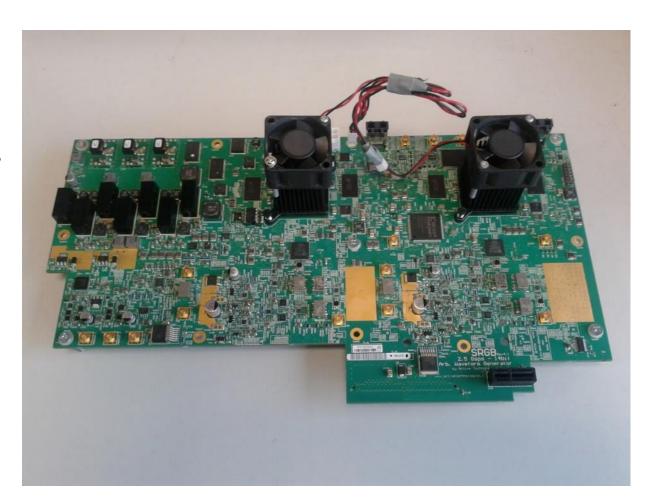
IL DIRIGENTE Dr.ssa Loredana Guglielmetti



OEM under development

A new OEM product is under development (covered by NDA)

- PSR: Q1-2016
- 18 layer PCB
- 3511 components
- 3 ground domains
- 28 power supplies





Cap. of complex HW design

Manicore application board

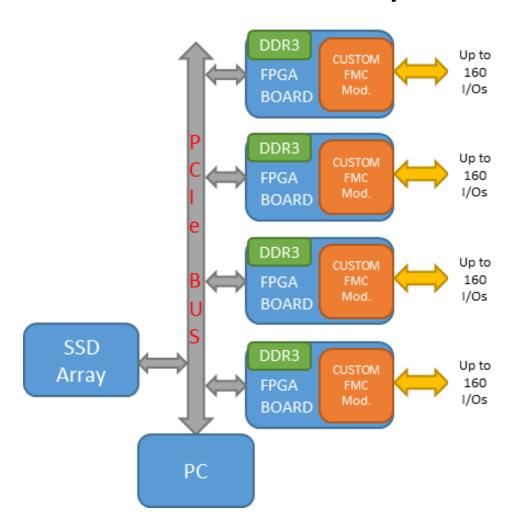
STMicroelectronics



12Gs/s ADC FPGA board for radar system (Italian Navy)







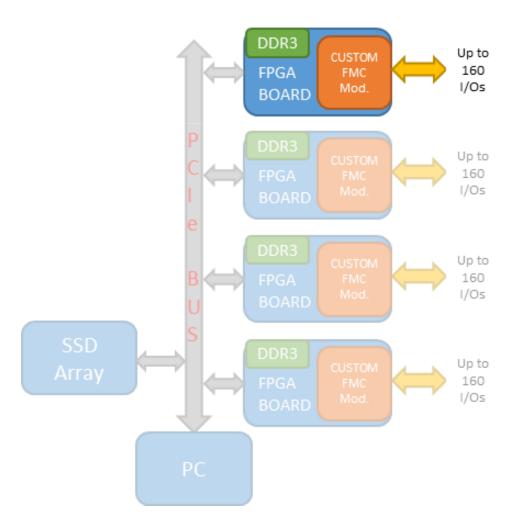
- 4GB/s continuous transfer rate
- 16TB storage capability
- Customizable HW front-end
- Multi rack synchronization











- Xilinx Kintex 7 or Kintex 7Ultrascale FPGA
 - LVDS + GTX to FMC module
- Custom FMC (Vita 57.1 std) module
 - ADC
 - DAC
 - High speed serial links
- Active Technologies' FMC modules
- Large set of COTS modules



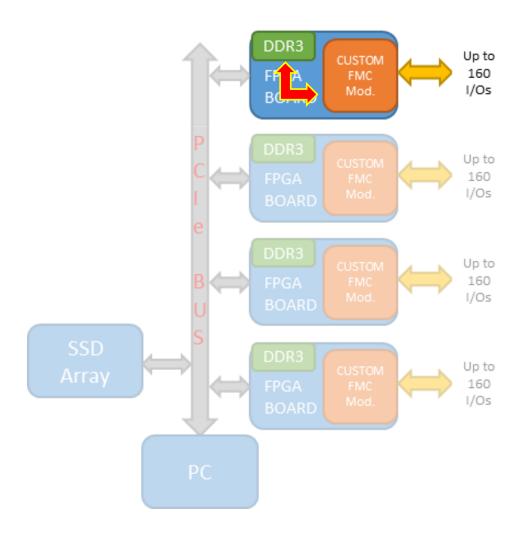


- The data transfer between front end and the mass memory is structured on three levels
 - I/O to local DDR3 module
 - I/O to PC DDR4 memory
 - I/O to SSD array

Transfer rate



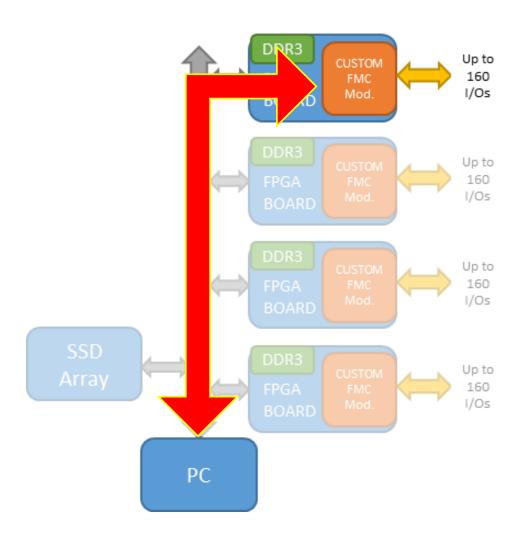
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- The FMC module is connected through FPGA to a local DDR3 SODIMM module:
 - 4GB depth (on K7 board)
 - Up to **8GB/s** transfer rate

Transfer rate





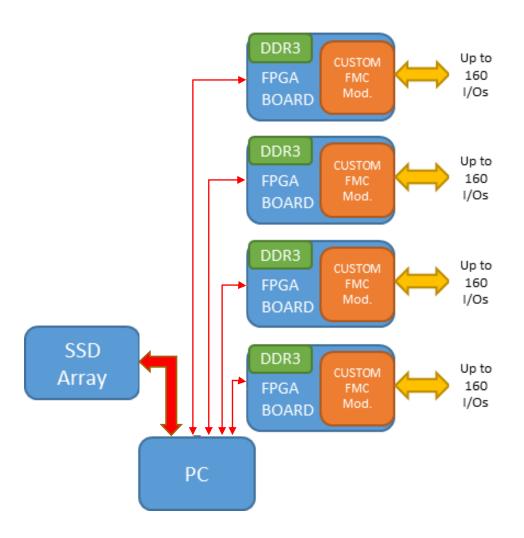
- The FPGA module is connected through PCIe 4x gen2 to the PC DDR4:
 - **64GB** depth (on K7 board)
 - Up to 2GB/s average transfer rate

The DDR3 SODIMM is used as **FIFO memory** (FIFO **IP** provided by Active Technologies) in order to guarantee zero interruption data transfer.

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Transfer rate





- The FPGA modules can read / write into SSD array:
 - 4GB/s continuous transfer rate
 - **16TB** storage capability

Active Technologies provides the IP to manage the local DDR3 FIFO buffer into FPGA cards as well as the API to manage the swap buffers into the DDR4 PC memory.

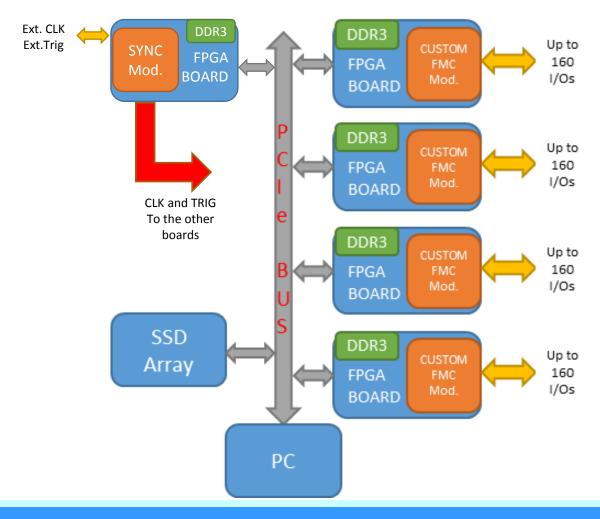


The synchronization of the system is manage by a sych. Board which distribute CLK and Trig.





Synchronization of the boards into the chassis





- Multi chassis synchronization up to 8 systems:
 - 5120 I/O Channels
 - 128 TB storage capacity
 - > 32GB/s continuous transfer rate





Innovative projects



- Active Technologies is working on two innovative projects to get:
 - A new 12Gs/s real time DAC 12/16bits (expected for Q3-2016)
 - A new wideband DC coupled amplifier
- Two main application areas:
 - High performance AWGs
 - 4 channel 12.5Gs/s 16bit
 - Innovative pulse generators
 - 5Vpp output range, <100ps rise time

DAC technology

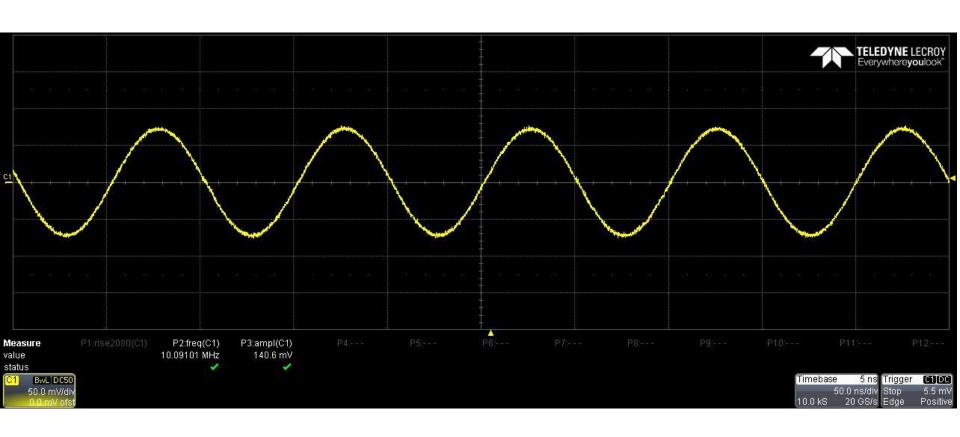


The first 8 bit version tape out is under test.

DAC technology



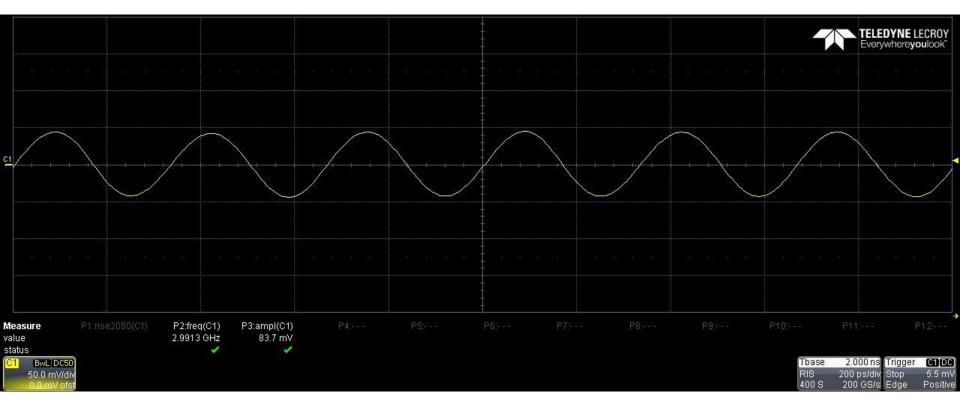
• 10 MHz sine wave



DAC technology



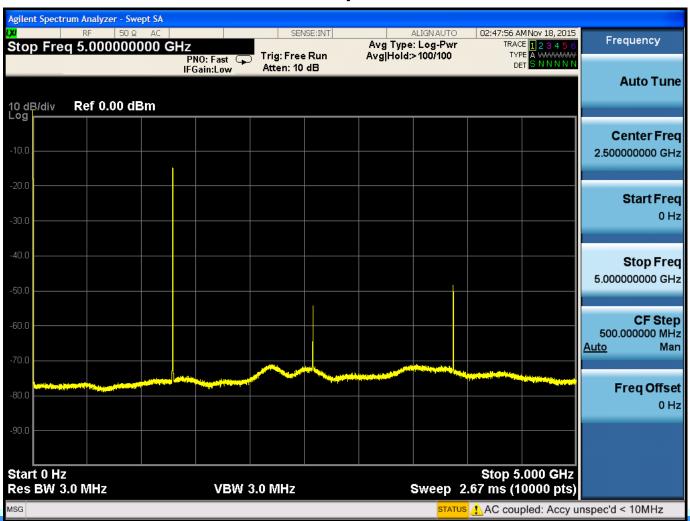
3 GHz sine wave (-4dB)







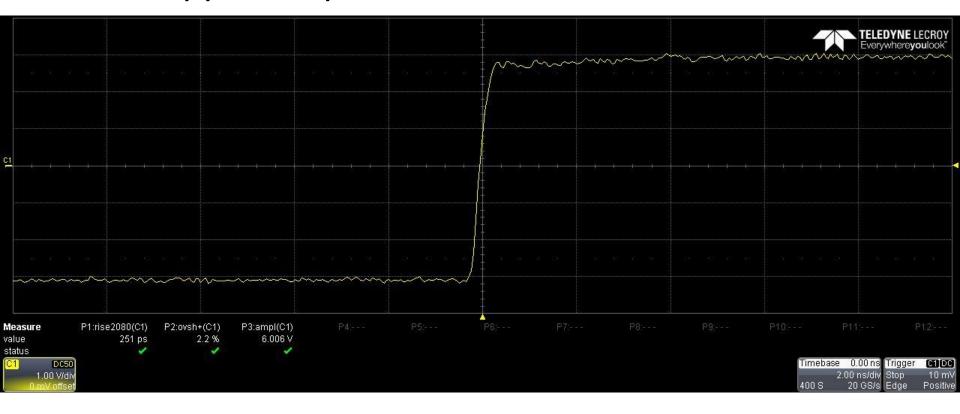
1.25 GHz sine wave spectrum: SFDR 35dB



DC coupled HV amplifier

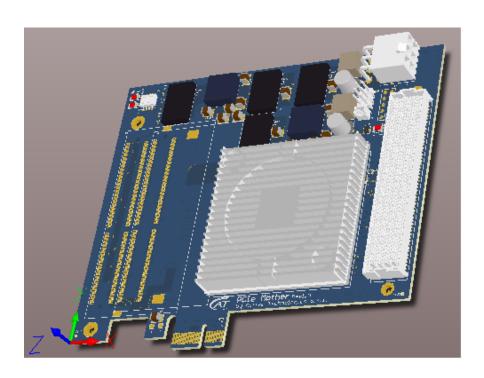


● 6Vpp – 250ps rise time



FPGA Carrier board





- Based on Kintex Ultrascale FPGA
- Up to 8GB DDR4 memory @ 250 Gbps bandwidth
- Up to 19 Transciever @16Gbps to FMC
- Up to 96 LVDS @1.25Gbps to FMC



Active Technologies

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would like to thank you for your time and consideration